

SPECIFICATION

CUSTOMER:	
MODULE NO.:	AGM 2004A-901



MODLE NO:

AGM 2004A-901

RECORDS OF REVISION

DOC. FIRST ISSUE

VERSION	DATE	REVISED PAGE NO.		SUMMARY			
0	2006/10/18		Fi	rst issue			
A	2008/10/27		Modify Backlight				
			in	formation			
В	2008/11/11		Modify Character				
			Ge	enerator ROM Pattern			
C	2012/05/16		Co	orrect ST7066IC			
			in	formation.			
D	2013/07/30		Re	emove IC information			
			M	odify B/L information			
Е	2014/05/13		Co	orrect R/W=H:			
			Re	ead(Module→MPU) L:			
			W	rite(MPU→Module)			

Contents

- 1.Precautions in use of LCD Modules
- 2.General Specification
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1.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) AGT have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9)AGT have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, AGT have the right to modify the version.)

2.General Specification

Item	Dimension	Unit					
Number of Characters	20 characters x 4Lines	_					
Module dimension	98.0 x 60.0 x 13.6(MAX)	mm					
View area	77.0 x 25.2	mm					
Active area	70.4 x 20.8	mm					
Dot size	ot size 0.55 x 0.55						
Dot pitch	0.60 x 0.60	mm					
Character size	2.95 x 4.75	mm					
Character pitch	3.55 x 5.35	mm					
LCD type	FSTN Negative Transmissive (In LCD production, It will occur slightly color can only guarantee the same color in the same by						
Duty	1/16						
View direction	6 o'clock						
Backlight Type	LED White						
IC	ST7066U						

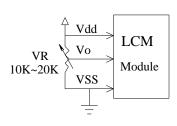
3.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V _I	V_{SS}	_	$V_{ m DD}$	V
Supply Voltage For Logic	$V_{ m DD} ext{-}V_{ m SS}$	-0.3	_	7	V
Supply Voltage For LCD	V_{DD} - V_{o}	-0.3	_	13	V

4.Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
Supply Voltage For LCD		Ta=-20°C	_	_	5.3	V
*Note	V_{DD} - V_{0}	Ta=25°℃	4.4	4.5	4.6	V
		Ta=70°C	3.8	_	_	V
Input High Volt.	V_{IH}	_	$0.7~V_{DD}$	_	V_{DD}	V
Input Low Volt.	V _{IL}	_	V _{SS}	_	0.6	V
Output High Volt.	V _{OH}	_	3.9	_	V_{DD}	V
Output Low Volt.	V_{OL}	_	0	_	0.4	V
Supply Current	I_{DD}	V _{DD} =5.0V	1.0	1.2	1.5	mA

^{*} Note: Please design the VOP adjustment circuit on customer's main board

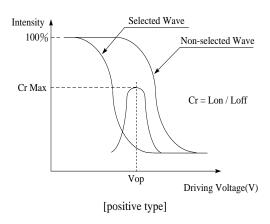


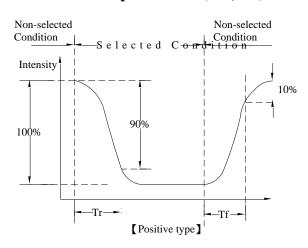
5.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	30	$\psi = 180^{\circ}$
X7 A1-	θ	CR≧2	0	_	60	$\Psi=0^{\circ}$
View Angle	θ	CR≧2	0	_	45	$\Psi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\psi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
D T'	T rise	_	_	150	200	ms
Response Time	T fall	_	_	150	200	ms

Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)





Conditions:

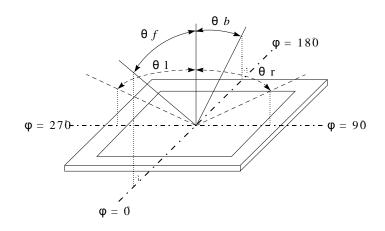
Operating Voltage: Vop

Viewing Angle(θ , φ): 0° , 0°

Frame Frequency: 64 HZ

Driving Waveform: 1/N duty, 1/a bias

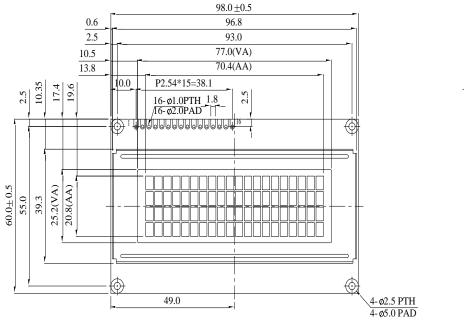
Definition of viewing angle($CR \ge 2$)

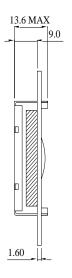


6.Interface Pin Function

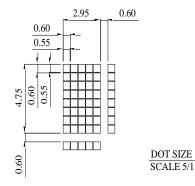
Pin No.	Symbol	Level	Description					
1	V _{SS}	0V	Ground					
2	$V_{ m DD}$	5.0V	upply Voltage for logic					
3	VO	(Variable)	Operating voltage for LCD					
4	RS	H/L	H: DATA, L: Instruction code					
5	R/W	H/L	H: Read(Module→MPU) L: Write(MPU→Module)					
6	Е	H,H→L	Chip enable signal					
7	DB0	H/L	Data bus line					
8	DB1	H/L	Data bus line					
9	DB2	H/L	Data bus line					
10	DB3	H/L	Data bus line					
11	DB4	H/L	Data bus line					
12	DB5	H/L	Data bus line					
13	DB6	H/L	Data bus line					
14	DB7	H/L	Data bus line					
15	A	_	Power supply for B/L(+)					
16	K	_	Power supply for B/L(-)					

7.Contour Drawing & Block Diagram

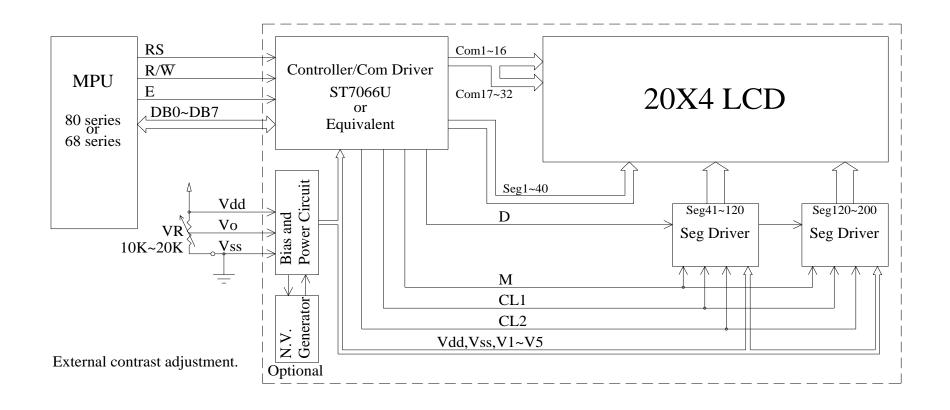




1 Vss 2 Vdd 3 Vo	
3 Vo	
4 RS	
5 R/W	
6 E	
7 DB0	
8 DB1	
9 DB2	
10 DB3	
11 DB4	
12 DB5	
13 DB6	
14 DB7	
15 A	
16 K	



The non-specified tolerance of dimension is ± 0.3 mm.



Character located DDRAM address DDRAM address DDRAM address DDRAM address

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F	10	11	12	13
40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F	50	51	52	53
14	15	16	17	18	19	1A	1B	1C	1D	1E	1F	20	21	22	23	24	25	26	27
54	1 55	56	57	58	59	5A	5B	5C	5D	5E	5F	60	61	62	63	64	65	66	67

8.Character Generator ROM Pattern

Table.2

Upper																
4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH		LHHH	HLLL	HLLH	HLHL	нгнн	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)				55 55 55 55 55 55 55 55 55 55 55 55 55			5555 5555 5555 55				55555	55 55 55 55 55 55 55 55 55 55 55 55 55	555 555 555		databada P P P P P P P P
LLLH	(2)		Paragraph Pa	100 100 100 100 100 100 100 100 100 100	10 10 10 10 10 10 10 10 10 10 10 10 10 1		555 5555 5555	55 55 5 555 5 555 5			555 555 555	55 55 55 55 55 55 55 55 55 55 55 55 55	50 50 50 50 50 50 50 50 50 50 50 50 50 5		5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	atala a a a a a a a a a a a a a a a a a
LLHL	(3)		10 10 10 10 10 10 10 10 10 10 10 10 10 1					5 5 5 5 5 5 5			55 55 55	4 0			dathana a a a a a a a a a a a a	
LLHH	(4)			**************************************		5 5 5555 5555 5555		555 555 5555			5555 5555	55 55 55 55 56 55	555 555 55 5	55555 55555 55555	555 555 5555	
LHLL	(5)				5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		55 55 55 55 55 55 55 55 55 55 55 55 55				555	5555 555 555 555 555	20000000000000000000000000000000000000	55555 5555 5555 5555	chhanana G G chana	
LHLH	(6)			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		2525255 505555 505555 505555 505555 505555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 50555 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 5055 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505 505	555 5555 5555 5555	55555 55555 55555 55555			10 10 10 10 10 10 10 10 10 10 10 10 10 1	1	55555 55555 5555 55	555 555 555 555		
LHHL	(7)			55 55 55 55 55 55 55							55555 55555 55555 5	555555	555 5555	55555 55555 55555 55555		100000 1000000 100000000
LHHH	(8)		10 15 15	55 55 55 55 55 55 55 55 55 55 55 55 55		4444444 4444 4444 4444 4444 4444 4444 4444	5555 5555 5555 555				55555 55 5	5555 5555 5555 5555	₽ "	- ■ "	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	
HLLL	(1)		1000 mm	55 55 55 55 55 55 55 55 55 55 55 55 55	55555555555555555555555555555555555555							55555 5555 5555 555				
HLLH	(2)			55 55 55 55 55 55 55 55 55 55 55 55 55	10 10 10 10 10 10 10 10 10 10 10 10 10 1		# ####################################	5 5 5 55 5 55 5 55			55555 5 55	10 10 10 10 10 10 10 10 10 10 10 10 10 1	4 4 44444			
HLHL	(3)		5 5 5 5 5 5 5 5 5	55 55 55	555555 55555 55555	**************************************	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	55555 5 5			55555 5 55555	555555 55 55 55			d danadana danadana	
нгнн	(4)		5 5 5555 5	10 10 10 10 10 10 10 10 10 10 10 10 10 1		**************************************					5555 555 555		**************************************	55 55 55 55 55 55 55 55 55 55 55 55 55	555	
HHLL	(5)		10 10 10 10		55555555555555555555555555555555555555		P P P P P P P P P P P P P P P P P P P				5555 555 555	55 5 55 5 555	55555 55 55 55	555555 5555 5555 5555	and	datata data data datata
HHLH	(6)		55555	55555 55555	55555555 55555555		50 50 50 50 50 50 50 50 50 50 50 50 50 5				555 5 5555	55555	5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5	252		5 55555
HHHL	(7)		10 10 10 10 10 10 10 10 10 10 10 10 10 1		10000000000000000000000000000000000000	5 5	10 10 10 10 10 10 10 10 10 10 10 10 10 1	5 5 5555 5				555 55 555 55 555 55	5 55 55 55 55 55 55 55 55 55 55 55 55 5	5 5		
нннн	(8)		5	55 55 55 55	**************************************	55555	555 5 5 5 5	5 55 55 5 5			5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5 5		55555 55 55 55	55 55 55 55		dereddered dereddered dereddered dereddered dereddered

9. Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test									
Test Item	Content of Test	Test Condition	Note							
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2							
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2							
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs								
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1							
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2							
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C	-20°C/70°C 10 cycles								
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3							
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k Ω CS=100pF 1 time								

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

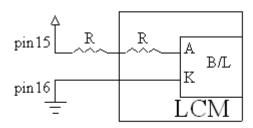
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	_	48	60	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	_
Reverse Voltage	VR	_	_	5	V	_
Luminance (Without LCD)	IV	448	560	_	CD/M ²	ILED=48mA
LED Life Time (For Reference only)	_	_	50K	_	Hr.	ILED=48mA 25°C,50-60%RH, (Note 1)
Color	White	•	•		•	

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.

2.Drive from pin15,pin16



(Will never get Vee output from pin15)

11.Inspection specification

NO	Item	Criterion				AQL
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect. Missing character, dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.				0.65
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 				2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi=(x+y)/2$ X 3.2 Line type:	↓	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.		Size Φ $ Φ \le 0.20 $ $ 0.20 < Φ \le 0.50 $ $ 0.50 < Φ \le 1.00 $ $ 1.00 < Φ $ $ Total Q TY$	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item	Criterion				
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
			Glass thickness a: LC	nip thickness CD side length		
		6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:				
		z: Chip thickness	y: Chip width	x: Chip length		
0.5	Chipped glass	Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5	
06		$1/2t < z \le 2t$	Not exceed 1/3k	x≤1/8a	2.5	
		6.1.2 Corner crack: $z: Chip thickness$ $Z \le 1/2t$ $1/2t < z \le 2t$	y: Chip width Not over viewing area Not exceed 1/3k e chips, x is the total len	x : Chip length $x \le 1/8a$ $x \le 1/8a$		

NO	Item	Criterion			AQL
	Glass	Symbols: x: Chip length y: Ch	ass thickness a: LCI	p thickness O side length	AQL
06			Chip length ≤ 1/8a on:	z: Chip thickness $0 < z \le t$	2.5
		y: Chip width $y \le L$ ① If the chipped area touch remain and be inspected ac ① If the product will be head be damaged. 6.2.3 Substrate protuberance.	cording to electrode t at sealed by the custon		

NO	Item	Criterion	AQL	
07	Cracked glass	The LCD with extensive crack is not acceptable.		
	Backlight	8.1 Illumination source flickers when lit.	0.65	
08		8.2 Spots or scratched that appear when lit must be judged.	2.5	
	elements	Using LCD spot, lines and contamination standards.		
		8.3 Backlight doesn't light or color wrong.	0.65	
	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5	
09		stains or other contamination.		
		9.2 Bezel must comply with job specifications.	0.65	
		10.1 COB seal may not have pinholes larger than 0.2mm or	2.5	
		contamination.		
		10.2 COB seal surface may not have pinholes through to the IC.	2.5	
		10.3 The height of the COB should not exceed the height	0.65	
	PCB · COB	indicated in the assembly diagram.		
		10.4 There may not be more than 2mm of sealant outside the	2.5	
		seal area on the PCB. And there should be no more than three		
		places.		
		10.5 No oxidation or contamination PCB terminals.	2.5	
10		10.6 Parts on PCB must be the same as on the production	0.65	
10		characteristic chart. There should be no wrong parts, missing		
		parts or excess parts.		
		10.7 The jumper on the PCB should conform to the product	0.65	
		characteristic chart.		
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5	
		screw hold pad, make sure it is smoothed down.		
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5	
		X		
		V		
		X * Y<=2mm2		
	Soldering	11.1 No un-melted solder paste may be present on the PCB.	2.5	
		11.2 No cold solder joints, missing solder connections,	2.5	
11		oxidation or icicle.		
		11.3 No residue or solder balls on PCB.	2.5	
		11.4 No short circuits in components on PCB.	0.65	

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12	appearance	component) is not burned into brown or black color.	
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for RoHs

1. AGTECHNOLOGIES PRODUTOS ELETRONICOS, Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

2. Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250° C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}\mathbb{C}$;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.